IME00-015

Washington, D.C. 20231

tansmitted herewith for filing is the Patent Application of:

Thventor: MARK HATZILAMBROU, CHESTER LEUNG, RAJAN WALIA, LIEN WEE LIANG, SUBHASH C. rustagi, mk radhakrishnan

ESD PROTECTION SYSTEM FOR HIGH FREQUENCY APPLICATIONS

Enclosed are:

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x

5 sheets of drawing(s) - formal.

An assignment of the invention to Institute of Microelectronics

An associate power of attorney

Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	Υ	SMALL ENTITY
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$.375.
TOTAL CLAIMS	35 -20=	15	x G =	\$ 135.
INDEP CLAIMS	2 -3=	0	× 40 =	\$ O.
MULTIPLE	DEPENDENT CLA	IM PRESENTED	+ 260 =	
		st	JB TOTAL	\$ 510 .
		As	SSIGNMENT	\$40.
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EXPRESS MAIL CERTIFICATE

Express Mail No. FF308663905 I Hereby Certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to: The Commissioner of Patents and Trademarks, Washington, DC 20231. Applicant and/or Attorney requests the date of deposit as the Filing Date.

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